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Wonmi-gu, Bucheon-shi, Kyunggi-do 420-031 (KR). KIM, Chul-Min [KR/KR]; 102-605 Sinho Apt., 840-98 Jeongja-dong, Jangan-gu, Suwon-shi 435-041 (KR).

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(74) Agent: AJU PATENT & LAW FIRM; 12th Floor, Poonglim Building, 823-1 Yeoksam-dong, Kangman-gu, Seoul 135-784 (KR).

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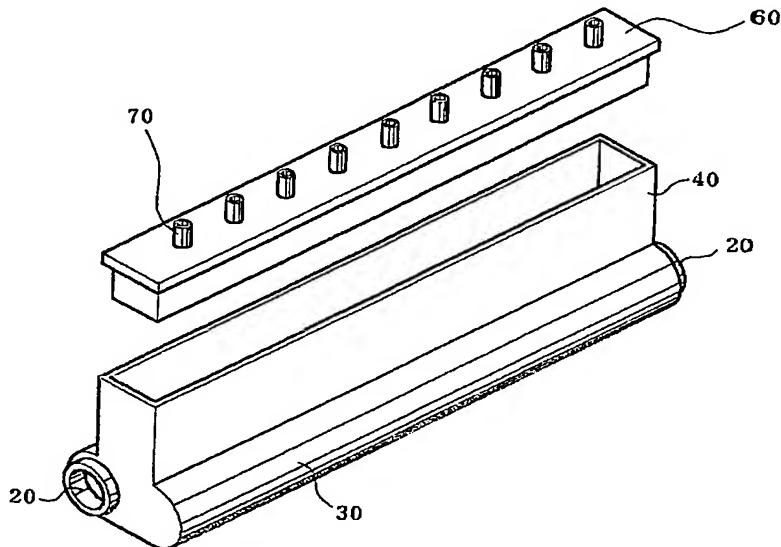
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(71) Applicant (for all designated States except US): LG CABLE LTD. [KR/KR]; 159 Samsung-dong, Kangnam-gu, Seoul 135-090 (KR).

(72) Inventors; and

(75) Inventors/Applicants (for US only): PARK, Won-Chan [KR/KR]; 1801-601 Bandal-maeul, Sang 1-dong,

(54) Title: LEAD FRAME PLATING APPARATUS



(57) Abstract: Disclosed herein is a lead frame plating apparatus. The lead frame plating apparatus comprises side inlets provided in the diagonal direction at opposite sides for supplying plating solution, a flow mixing room defined with an inner space in the longitudinal direction, a plating solution outlet for guiding the plating solution in the direction of nozzles, and a plating solution distribution part provided with the nozzles at an upper part of the plating solution outlet. Each nozzle is provided, at the lower end thereof, with a divergent-shaped expansion tube such that an inner diameter of the inlet of the expansion tube, larger than that of the nozzle, gradually decreases to an extent of the inner diameter of the nozzle. The lead frame plating apparatus supplies the plating solution through the nozzles with a uniform distribution.



TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW,  
ML, MR, NE, SN, TD, TG).

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